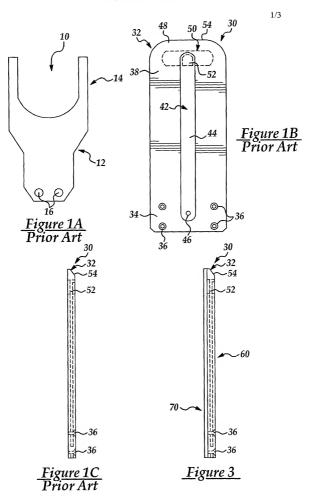
Inventor(s): Hsu
Serial No.: To Be Assigned
Filed: Herewith

For: Wafer Blade Equipped With Piezoelectric Sensors Attorney Docket No.: 67,200-531



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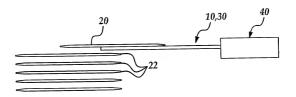
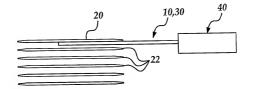


Figure 2A Prior Art



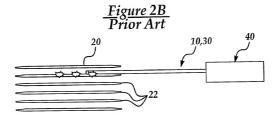
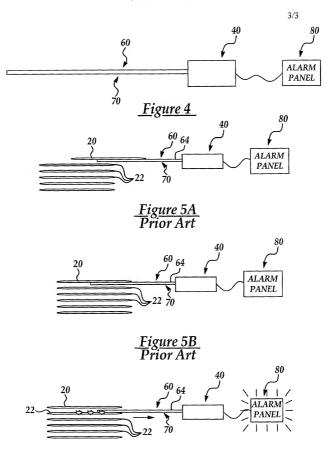


Figure 2C Prior Art

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<u>Figure 5C</u> Prior Art